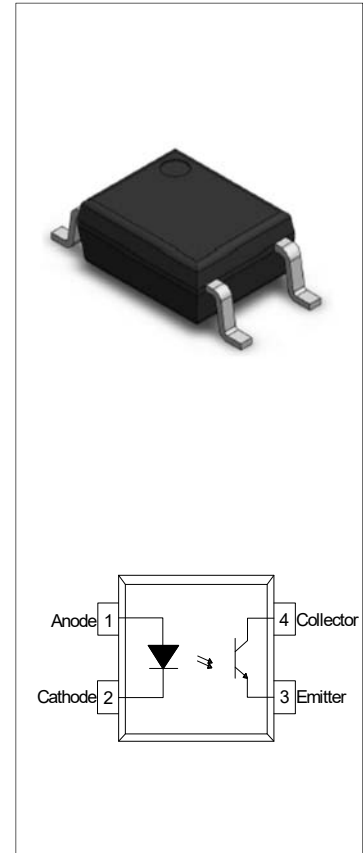


### DESCRIPTION:

The products are transistor opto-couplers in a plastic SOP4 package. The device combines an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector. With the robust coplanar double mold structure, the device provides the most stable isolation feature. The products are widely used in switch mode power supplies, programmable controllers, household appliances and office equipment.



### MAIN FEATURES

- High isolation 3750 VRMS
- Operating temperature range -55°C to 125°C
- RoHS & REACH Compliance
- HBM: H3A; MM: M4; CDM:C3
- CQC approved
- VDE approved
- UL approved
- AECQ101 approved

### ABSOLUTE MAXIMUM RATINGS (Temperature=25°C)

| Parameter               |                           | Symbol    | Value             | Unit |
|-------------------------|---------------------------|-----------|-------------------|------|
| Input                   | Forward Current           | $I_F$     | 50                | mA   |
|                         | Peak Forward Current      | $I_{FP}$  | 1 <sup>①</sup>    | A    |
|                         | Reverse Voltage           | $V_R$     | 6                 | V    |
|                         | Power Dissipation         | $P_D$     | 75                | mW   |
| Output                  | Collector-emitter Voltage | $V_{CEO}$ | 80                | V    |
|                         | Emitter-collector Voltage | $V_{ECO}$ | 7                 | V    |
|                         | Collector Current         | $I_C$     | 50                | mA   |
|                         | Power Dissipation         | $P_C$     | 150               | mW   |
| Total Power Dissipation |                           | $P_{tot}$ | 225               | mW   |
| Isolation Voltage       |                           | $V_{iso}$ | 3750 <sup>②</sup> | Vrms |
| Operating Temperature   |                           | $T_{opr}$ | -55~+125          | °C   |
| Junction Temperature    |                           | $T_j$     | 135               | °C   |

|                       |                  |          |    |
|-----------------------|------------------|----------|----|
| Storage Temperature   | T <sub>stg</sub> | -55~+125 | °C |
| Soldering Temperature | T <sub>sol</sub> | 260      | °C |

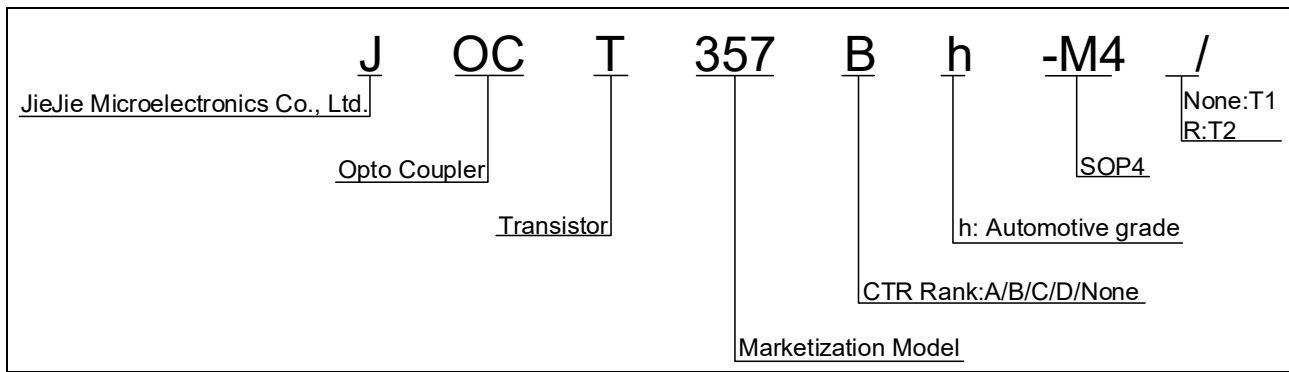
**NOTE1**: 100μs pulse, 100Hz frequency**NOTE2**: AC for 1minute, R.H.=40~60%**ELECTRICAL CHARACTERISTICS** (Temperature=25°C)

| Parameter                |                                      | Symbol               | Condition  | Min.             | Typ.             | Max. | Unit |
|--------------------------|--------------------------------------|----------------------|--|------------------|------------------|------|------|
| Input                    | Forward Voltage                      | V <sub>F</sub>       | I <sub>F</sub> =10mA   | -                | 1.2              | 1.5  | V    |
|                          | Reverse Current                      | I <sub>R</sub>       | V <sub>R</sub> =6V   | -                | -                | 1    | μA   |
|                          | Terminal Capacitance                 | C <sub>t</sub>       | V=0,<br>f=1MHz   | -                | 10               | -    | pF   |
| Output                   | Collector-Emitter dark current       | I <sub>CEO</sub>     | V <sub>CE</sub> =20V,<br>I <sub>F</sub> =0                                   | -                | -                | 100  | nA   |
|                          | Collector-Emitter breakdown voltage  | BV <sub>CEO</sub>    | I <sub>C</sub> =0.1mA<br>I <sub>F</sub> =0                                   | 80               | -                | -    | V    |
|                          | Emitter-Collector breakdown voltage  | BV <sub>ECO</sub>    | I <sub>E</sub> =0.1mA<br>I <sub>F</sub> =0                                   | 7                | -                | -    | V    |
| Transfer Characteristics | Current transfer ratio               | CTR <sup>①</sup>     | I <sub>F</sub> =5mA<br>V <sub>CE</sub> =5V                                   | 80               | -                | 600  | %    |
|                          | Collector-Emitter Saturation Voltage | V <sub>CE(sat)</sub> | I <sub>F</sub> =20mA<br>I <sub>C</sub> =1mA                                  | -                | 0.06             | 0.2  | V    |
|                          | Isolation resistance                 | R <sub>IO</sub>      | DC500V<br>40~60%R.H.   | 10 <sup>12</sup> | 10 <sup>14</sup> | -    | Ω    |
|                          | Floating Capacitance                 | C <sub>IO</sub>      | V=0,<br>f=1MHz   | -                | 0.4              | 1    | pF   |
|                          | Cut-off Frequency                    | f <sub>c</sub>       | V <sub>CE</sub> =5V,<br>I <sub>C</sub> =2mA<br>R <sub>L</sub> =100Ω,<br>-3dB | -                | 80               | -    | kHz  |
|                          | Rise Time                            | t <sub>r</sub>       | V <sub>CE</sub> =2V,<br>I <sub>C</sub> =2mA<br>R <sub>L</sub> =100Ω          | -                | 3                | 18   | μs   |
|                          | Fall Time                            | t <sub>f</sub>       |  | -                | 4                | 18   | μs   |
|                          | Response Time                        | t <sub>on</sub>      |  | -                | 6                | 25   | μs   |
| t <sub>off</sub>         |                                      | -                    |  | 5                | 25               | μs   |      |

**NOTE1**: Rank Table of Current Transfer Ratio (Temperature=25°C)

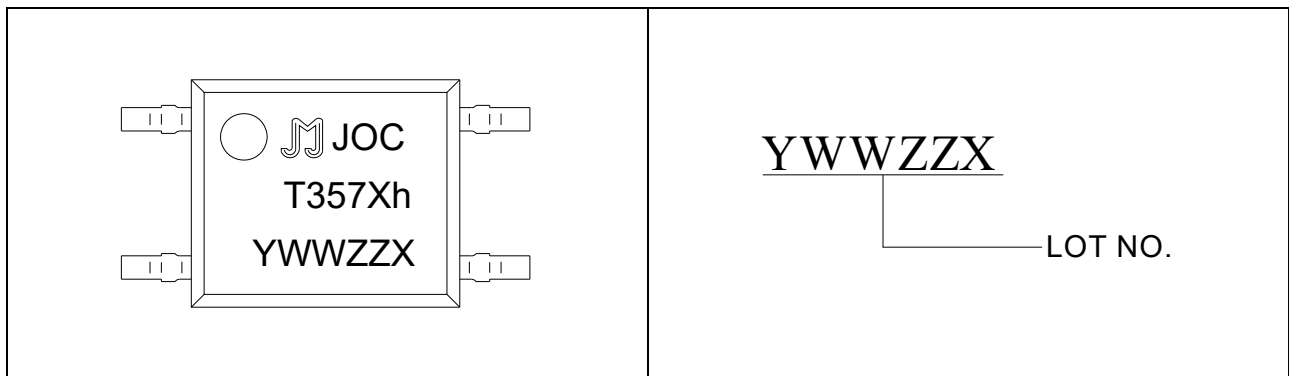
| Grade Sign | Min. (%) | Max. (%) |
|------------|----------|----------|
| None       | 80       | 600      |
| A          | 80       | 160      |
| B          | 130      | 260      |
| C          | 200      | 400      |
| D          | 300      | 600      |
| E          | 400      | 600      |
| Q          | 100      | 200      |

**ORDERING INFORMATION**



| Packing Quantity |                 |
|------------------|-----------------|
| Option           | Quantity        |
| None/R           | 3000 Units/Reel |

**MARKING**



Characteristics Curves

FIG.1: Max. Allowable LED Forward Current vs. Ambient Temperature

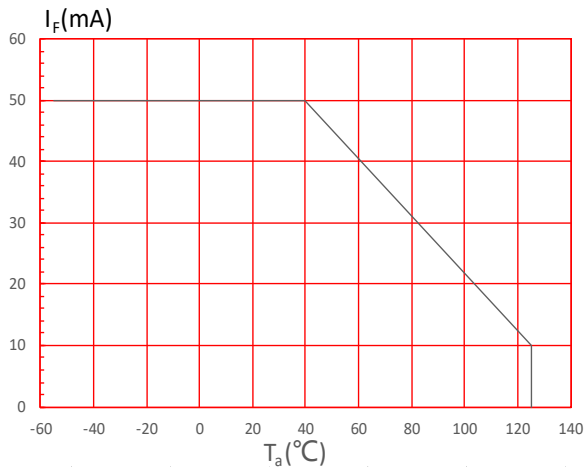


FIG.2: Collector Power Dissipation vs. Ambient Temperature

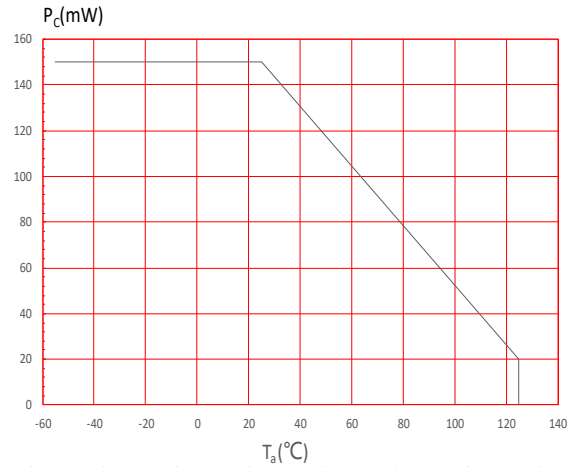


FIG.3: Forward Current vs. Forward Voltage

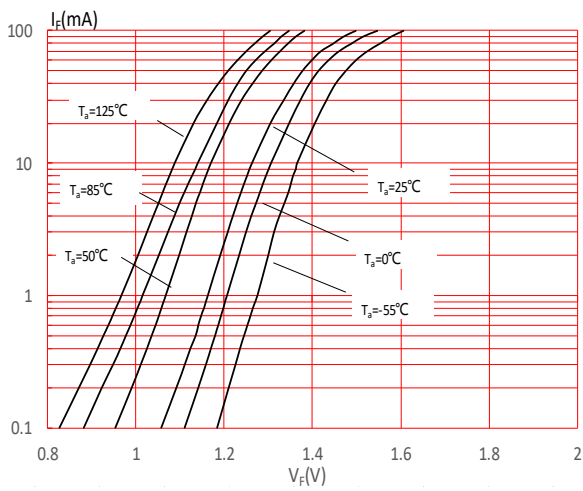


FIG.4: Normalized Collector Dark Current vs. Ambient Temperature

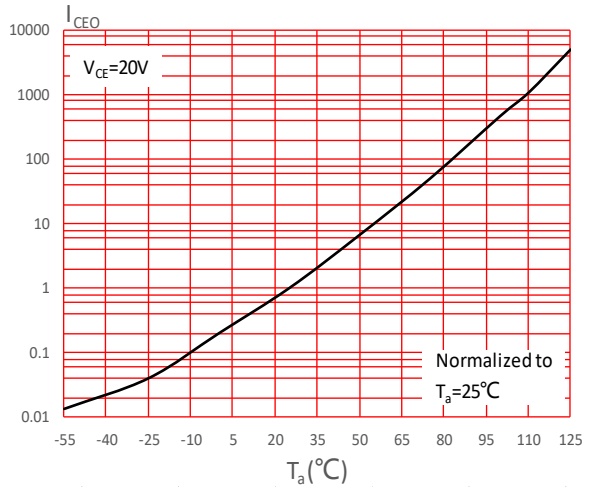


FIG.5: Collector Current vs. Collector-emitter Voltage

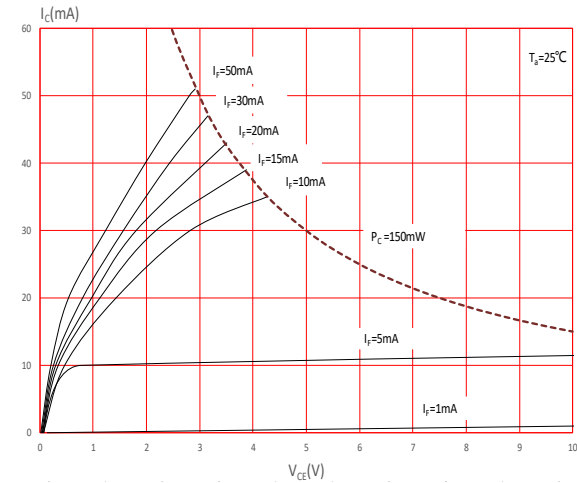
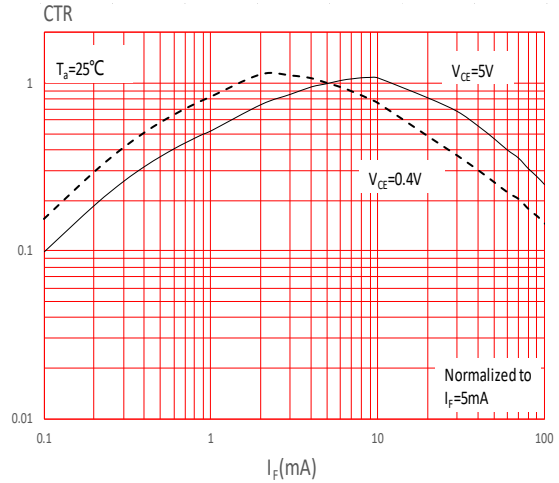
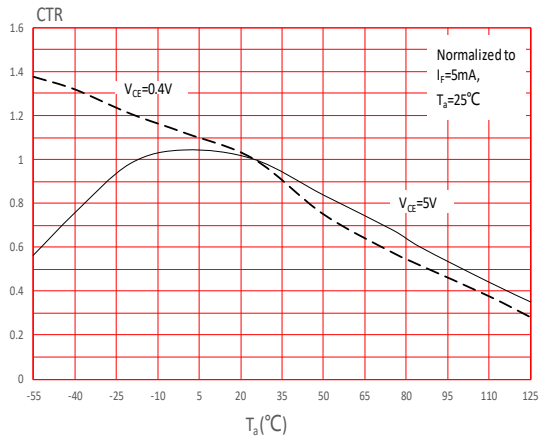


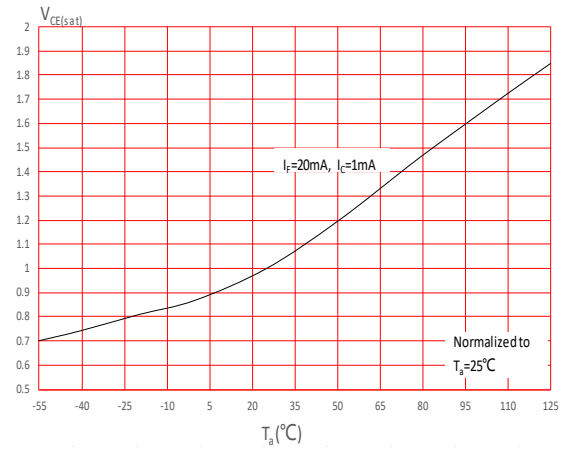
FIG.6: Normalized Current Transfer Ratio vs. Forward Current



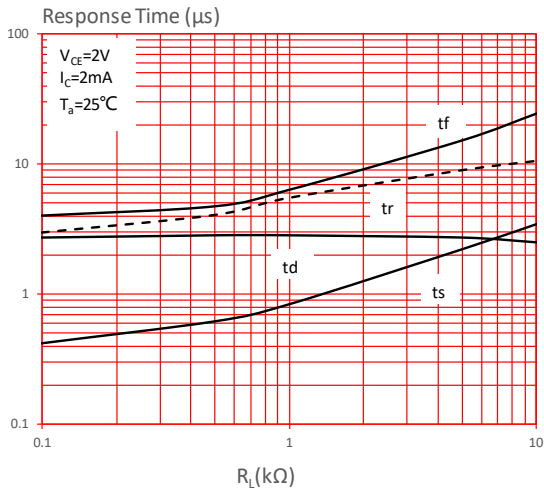
**FIG.7:** Normalized Current Transfer Ratio vs. Ambient Temperature



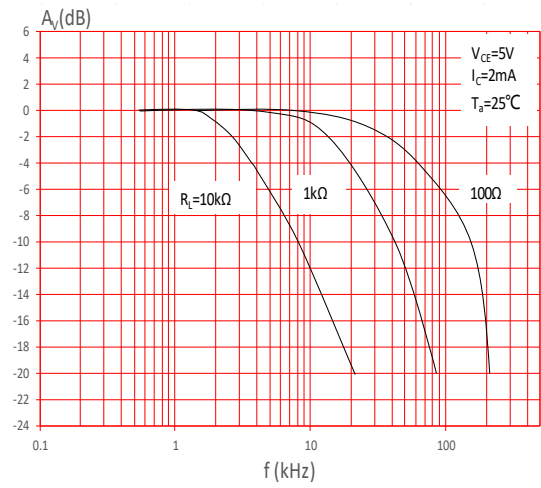
**FIG.8:** Normalized Collector-emitter Saturation Voltage vs. Ambient Temperature



**FIG.9:** Response Time vs. Load Resistance



**FIG.10:** Frequency Response



Test Circuits

FIG.11: Test Circuits of Response Time

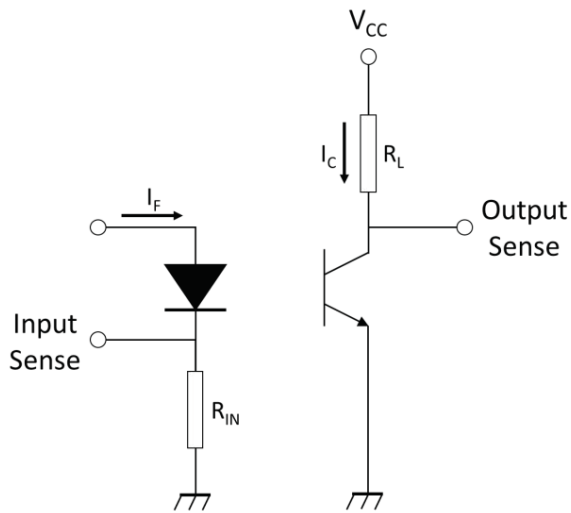


FIG.12: Curves of Response Time

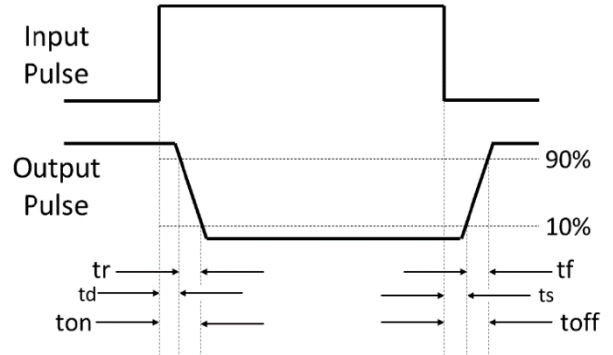
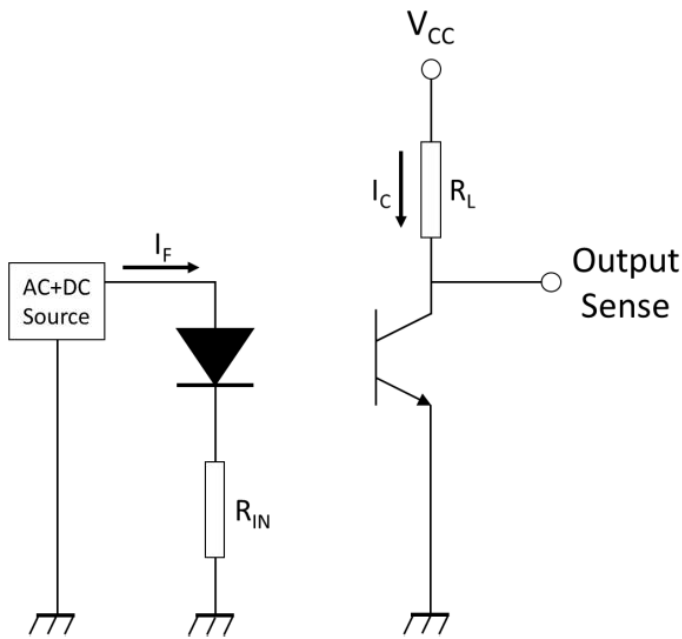
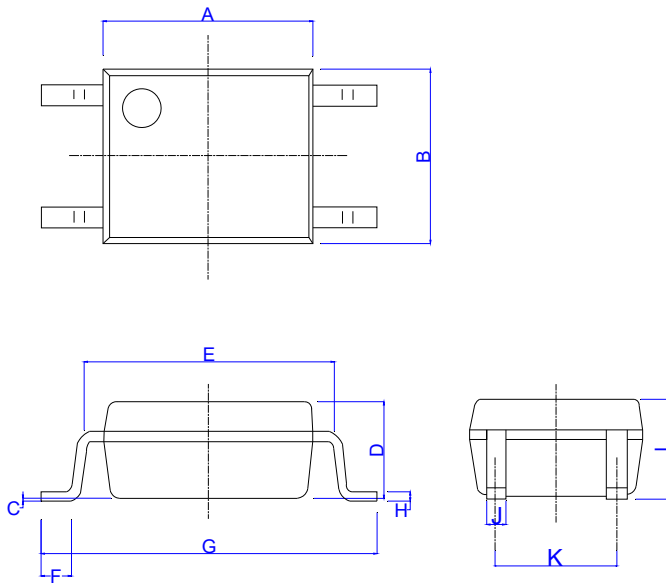


FIG.13: Test Circuits of Frequency Response

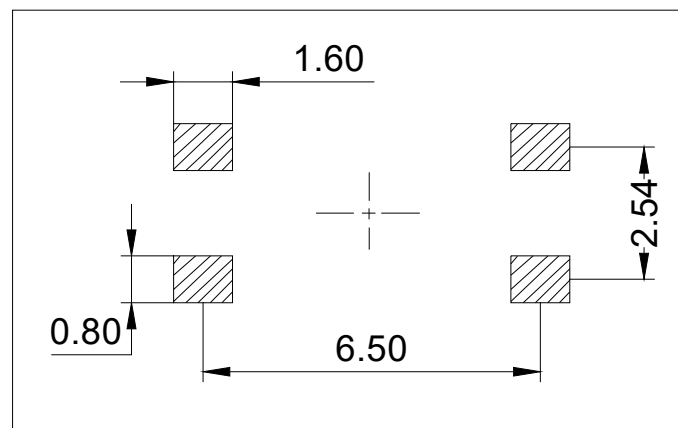


Package Dimension (Unit: mm)



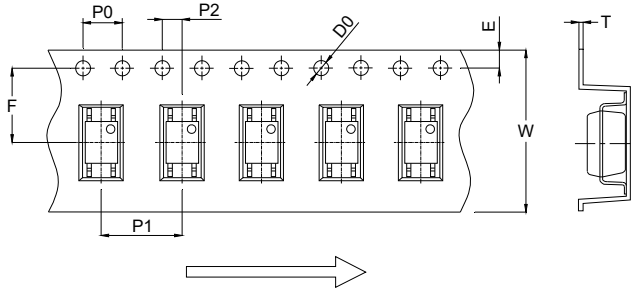
| Ref. | Dimensions  |      |      |        |      |       |
|------|-------------|------|------|--------|------|-------|
|      | Millimeters |      |      | Inches |      |       |
|      | Min.        | Typ. | Max. | Min.   | Typ. | Max.  |
| A    | 4.40        |      | 4.80 | 0.173  |      | 0.189 |
| B    | 3.60        |      | 4.20 | 0.142  |      | 0.165 |
| C    | 0.00        |      | 0.20 | 0.000  |      | 0.008 |
| D    | 1.90        |      | 2.30 | 0.075  |      | 0.091 |
| E    | 5.00        |      | 5.60 | 0.197  |      | 0.220 |
| F    | 0.34        |      | 0.94 | 0.013  |      | 0.037 |
| G    | 6.70        |      | 7.30 | 0.264  |      | 0.287 |
| H    | 0.10        |      | 0.30 | 0.004  |      | 0.012 |
| I    | 2.00        |      | 2.40 | 0.079  |      | 0.094 |
| J    | 0.25        |      | 0.55 | 0.010  |      | 0.022 |
| K    | 2.29        |      | 2.79 | 0.090  |      | 0.110 |

RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)



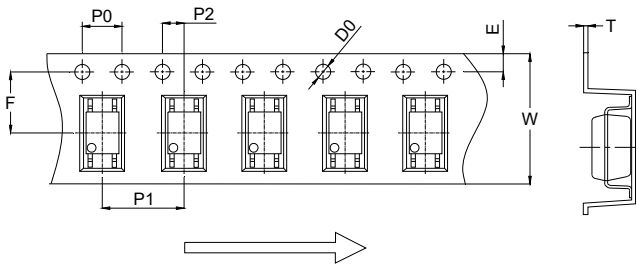
**CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)**

**Option None**



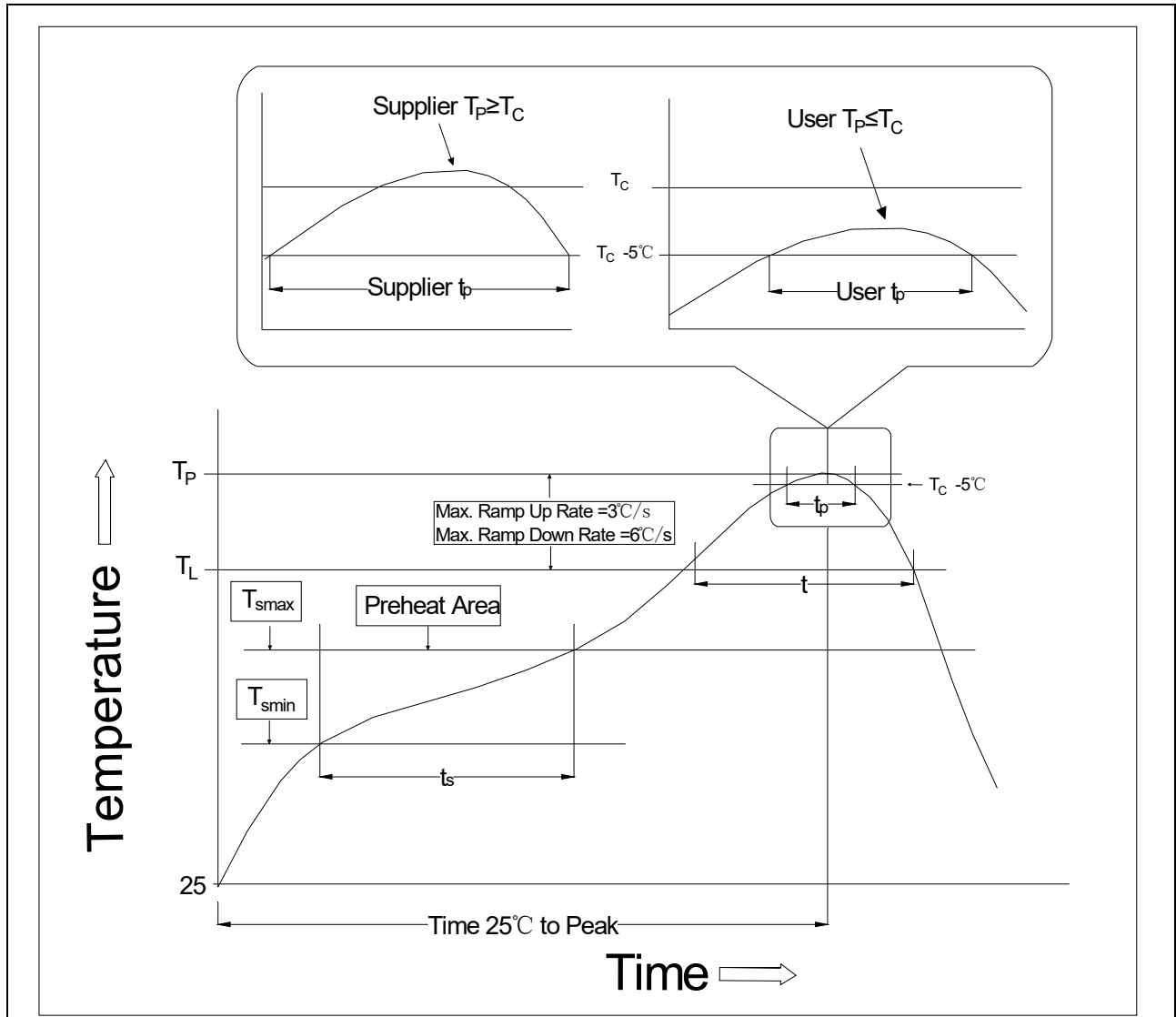
| Ref. | Dimensions  |       |       |        |       |       |
|------|-------------|-------|-------|--------|-------|-------|
|      | Millimeters |       |       | Inches |       |       |
|      | Min.        | Typ.  | Max.  | Min.   | Typ.  | Max.  |
| D0   |             | 1.50  | 1.60  |        | 0.059 | 0.063 |
| P0   | 3.90        | 4.00  | 4.10  | 0.154  | 0.157 | 0.161 |
| P1   | 7.90        | 8.00  | 8.10  | 0.311  | 0.315 | 0.319 |
| P2   | 1.90        | 2.00  | 2.10  | 0.075  | 0.079 | 0.083 |
| E    | 1.65        | 1.75  | 1.85  | 0.065  | 0.069 | 0.073 |
| F    | 7.40        | 7.50  | 7.60  | 0.291  | 0.295 | 0.299 |
| T    | 0.27        | 0.30  | 0.33  | 0.011  | 0.012 | 0.013 |
| W    | 15.80       | 16.00 | 16.20 | 0.622  | 0.630 | 0.638 |

**Option R**



| Ref. | Dimensions  |       |       |        |       |       |
|------|-------------|-------|-------|--------|-------|-------|
|      | Millimeters |       |       | Inches |       |       |
|      | Min.        | Typ.  | Max.  | Min.   | Typ.  | Max.  |
| D0   |             | 1.50  | 1.60  |        | 0.059 | 0.063 |
| P0   | 3.90        | 4.00  | 4.10  | 0.154  | 0.157 | 0.161 |
| P1   | 7.90        | 8.00  | 8.10  | 0.311  | 0.315 | 0.319 |
| P2   | 1.90        | 2.00  | 2.10  | 0.075  | 0.079 | 0.083 |
| E    | 1.65        | 1.75  | 1.85  | 0.065  | 0.069 | 0.073 |
| F    | 4.40        | 4.50  | 4.60  | 0.173  | 0.177 | 0.181 |
| T    | 0.25        | 0.30  | 0.35  | 0.010  | 0.012 | 0.014 |
| W    | 11.90       | 12.00 | 12.30 | 0.469  | 0.472 | 0.484 |

REFLOW INFORMATION




| Profile Feature   | Sn-Pb Assembly Profile | Pb-Free Assembly Profile |
|---|------------------------|--------------------------|
| Temperature Min. (T <sub>smin</sub> )                                 | 100                    | 150°C                    |
| Temperature Max. (T <sub>smax</sub> )                                 | 150                    | 200°C                    |
| Time (t <sub>s</sub> ) from (T <sub>smin</sub> to T <sub>smax</sub> ) | 60-120 seconds         | 60-120 seconds           |
| Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )                      | 3°C/second max.        | 3°C/second max.          |
| Liquidus Temperature (T <sub>L</sub> )                                | 183°C                  | 217°C                    |
| Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )             | 60-150 seconds         | 60-150 seconds           |
| Peak Body Package Temperature   | 235°C+0°C/-5°C         | 260°C+0°C/-5°C           |
| Time (t <sub>P</sub> ) within 5°C of 260°C                            | 20 seconds             | 30 seconds               |
| Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )                    | 6°C/second max.        | 6°C/second max.          |
| Time 25°C to Peak Temperature   | 6 minutes max.         | 8 minutes max.           |

Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.
2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum storage temperature.
3. Application of pressure on the epoxy body is prohibited at elevated temperatures. In specific scenarios, any applied force must not exceed 2.5N.
4. Ensure the component has cooled to ambient temperature before proceeding with any subsequent manufacturing steps.
5. The component has a shelf life of one year when stored under standard conditions.
6. Recommend storage Temp.: 0~40°C;  
Recommend storage humidity: <60%;  
MSL level: MSL 1

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